

MOSFET – Power, Single N-Channel 40 V, 3.5 m Ω , 101 A

NVD5C446N

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	± 20	V
Continuous Drain Cur-	Steady State	T _C = 25°C	I _D	105	Α
rent R _{θJC} (Notes 1 & 3)		T _C = 100°C		74	
Power Dissipation R _{θJC}		T _C = 25°C	P_{D}	66	W
(Note 1)		T _C = 100°C		33	
Continuous Drain	Steady State	T _A = 25°C	I _D	22	Α
Current R _{0JA} (Notes 1, 2 & 3)		T _A = 100°C		16	
Power Dissipation $R_{\theta JA}$		T _A = 25°C	P_{D}	3.1	W
(Notes 1 & 2)		T _A = 100°C		1.5	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	590	Α
Operating Junction and Storage Temperature		T _J , T _{stg}	-55 to 175	°C	
Source Current (Body Diode)			I _S	73	Α
Single Pulse Drain-to-Source Avalanche Energy ($T_J = 25^{\circ}C$, $I_{L(pk)} = 11$ A)			E _{AS}	214	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T _L	260	°C	

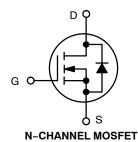
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	2.28	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	48	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

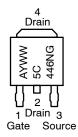
V _{(BR)DSS}	R _{DS(on)}	I _D
40 V	3.5 m Ω @ 10 V	101 A





DPAK CASE 369C STYLE 2

MARKING DIAGRAM & PIN ASSIGNMENT



A = Assembly Location

Y = Year
WW = Work Week
5C446N = Device Code
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				•		•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				19		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V.	T _J = 25°C			10	μΑ
	ate Voltage Drain Current $V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$	T _J = 125°C			250	1	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)						•	•
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				7.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D	= 50 A		2.9	3.5	mΩ
Forward Transconductance	9FS	$V_{DS} = 3 \text{ V}, I_{D}$	= 50 A		100		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES				•		•
Input Capacitance	C _{iss}				2300		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}, $ $V_{DS} = 25 \text{ V}$			1200		1
Reverse Transfer Capacitance	C _{rss}				46		1
Total Gate Charge	Q _{G(TOT)}				34.3		nC
Threshold Gate Charge	Q _{G(TH)}				5.0		1
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, V_{DS} = 32 \text{ V},$ $I_{D} = 50 \text{ A}$			12.2		1
Gate-to-Drain Charge	Q_{GD}				5.8		1
Plateau Voltage	V_{GP}				7.2		V
SWITCHING CHARACTERISTICS (Note 5)	1		<u>_</u>			I	1
Turn-On Delay Time	t _{d(on)}				20		ns
Rise Time	t _r	Voc = 10 V Vp	o = 32 V		62		1
Turn-Off Delay Time	t _{d(off)}	V_{GS} = 10 V, V_{DS} = 32 V, I_{D} = 50 A, R_{G} = 2.5 Ω			43		1
Fall Time	t _f				17		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	T _J = 25°C		0.9	1.2	V
-			T _J = 125°C		0.8		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dIs/dt = 100 A/ μ s, I _S = 50 A			46		ns
Charge Time	ta				23		1
Discharge Time	tb				23		1
Reverse Recovery Charge	Q _{RR}				40		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

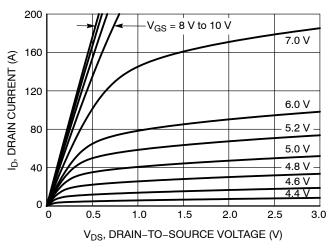


Figure 1. On-Region Characteristics

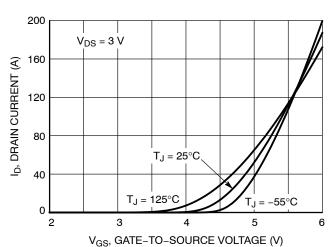


Figure 2. Transfer Characteristics

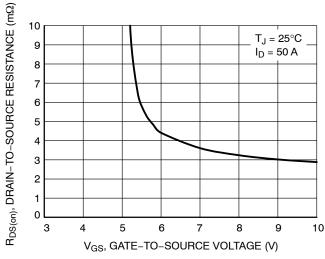


Figure 3. On-Resistance vs. Gate-to-Source Voltage

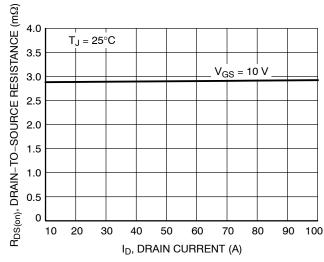


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

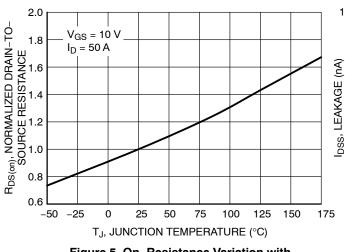


Figure 5. On–Resistance Variation with Temperature

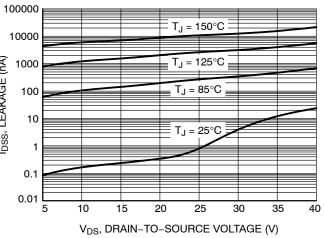


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

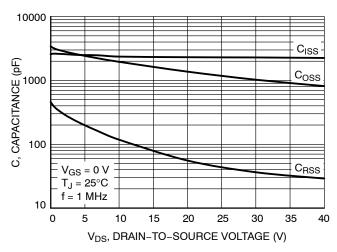


Figure 7. Capacitance Variation

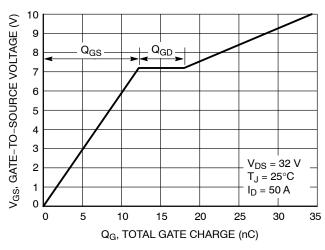


Figure 8. Gate-to-Source vs. Total Charge

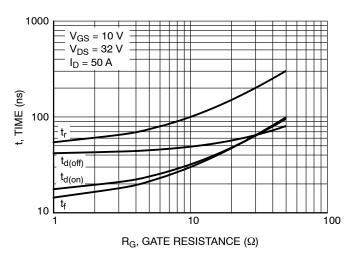


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

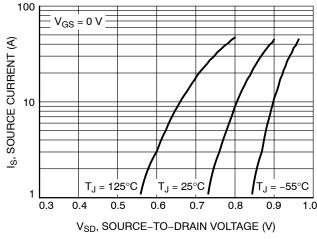


Figure 10. Diode Forward Voltage vs. Current

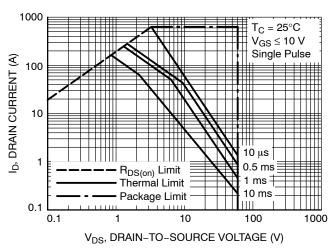


Figure 11. Maximum Rated Forward Biased Safe Operating Area

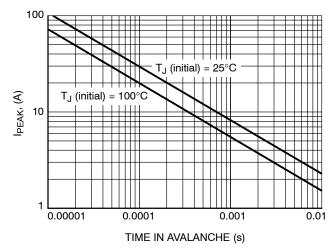


Figure 12. $I_{\mbox{\scriptsize PEAK}}$ vs. Time in Avalanche

TYPICAL CHARACTERISTICS

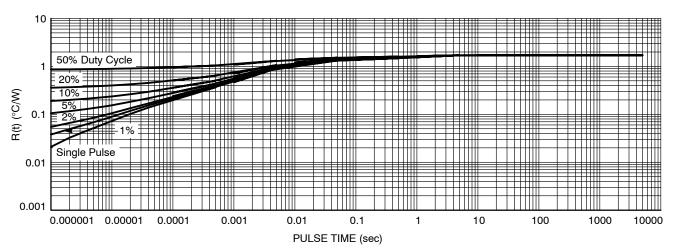


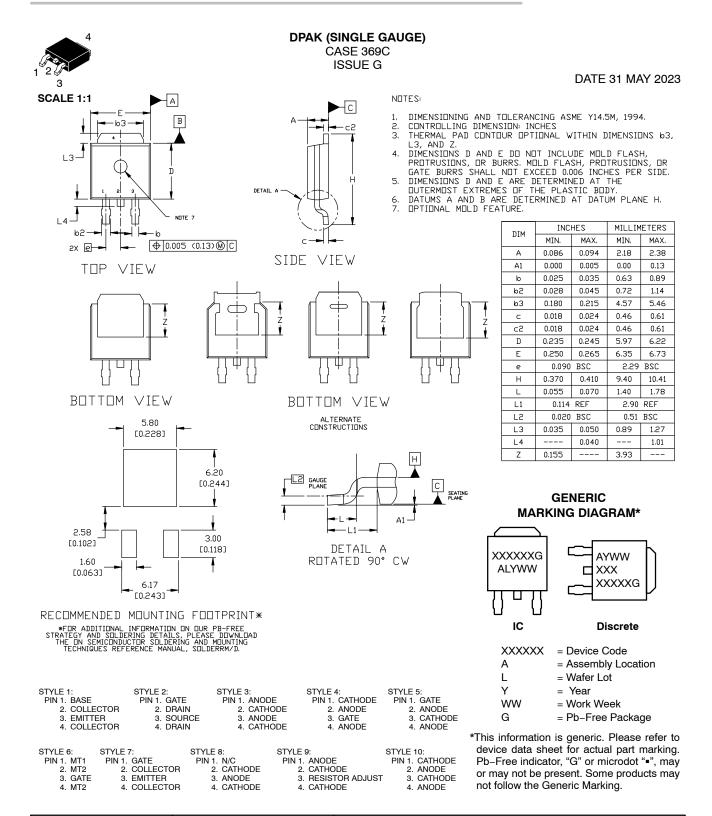
Figure 13. Thermal Characteristics

ORDERING INFORMATION

Order Number	Package	Shipping [†]
NVD5C446NT4G	DPAK (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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DESCRIPTION:	DPAK (SINGLE GAUGE)		PAGE 1 OF 1	

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